

## **General Description**

The DS1081L is a spread-spectrum clock modulator IC that reduces EMI in high clock-frequency-based, digital electronic equipment.

Using an integrated phase-locked loop (PLL), the DS1081L accepts an input clock signal in the range of 20MHz to 134MHz and delivers a spread-spectrum modulated output clock signal. The PLL modulates, or dithers, the output clock about the center input frequency at a pin-selectable magnitude and dither rate, allowing direct EMI control and optimization. In addition, through an enable pin the dithering can be enabled or disabled for easy comparison of system performance during EMI testing. This same input pin also allows the DS1081L output to be tri-stated.

By dithering the system clock, all the address, data, and timing signals generated from this signal are also dithered so that the measured EMI at the fundamental and harmonic frequencies is greatly reduced. This is accomplished without changing clock rise/fall times or adding the space, weight, design time, and cost associated with mechanical shielding.

The DS1081L is provided in an 8-pin TSSOP package and operates over a full automotive temperature range of  $-40^{\circ}$ C to  $+125^{\circ}$ C.

### **Applications**

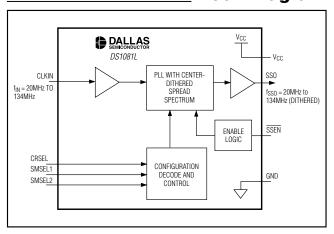
LCD Panels for TVs, Desktop Monitors, and Notebook and Tablet PCs

Automotive Telematics and Infotainment

**Printers** 

Pin Configuration and Typical Operating Circuit appear at end of data sheet.

### **Block Diagram**



# **Features**

- Modulates a 20MHz to 134MHz Clock with Center Spread-Spectrum Dithering
- **♦** Selectable Spread-Spectrum Modulation Magnitudes of:

±0.5%

±1.0%

±1.5%

±2.0%

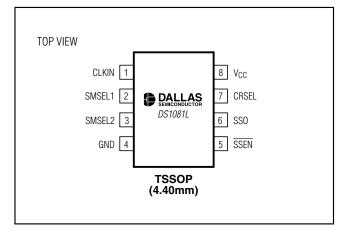
- **♦ Low 75ps Cycle-to-Cycle Jitter**
- **♦** Spread-Spectrum Disable Mode
- ♦ Pin Compatible with Alliance/PulseCore Semiconductor P2040 Series Devices
- **♦ Clock Output Disable**
- **♦ Low Cost**
- **♦ Low Power Consumption**
- ♦ 3.3V Single Voltage Supply
- ♦ -40°C to +125°C Temperature Range
- **♦ Small 8-Pin TSSOP Package**

### **Ordering Information**

PART	TEMP RANGE	PIN-PACKAGE
DS1081LE+	-40°C to +125°C	8 TSSOP
DS1081LE+T	-40°C to +125°C	8 TSSOP

- +Denotes lead-free package.
- T Denotes tape-and-reel.

# Pin Configuration



### **ABSOLUTE MAXIMUM RATINGS**

Voltage Range on V<sub>CC</sub> Relative to GND .......-0.5V to +3.63V
Voltage Range on Any Lead Relative
to GND .....-0.5V to (V<sub>CC</sub> + 0.5V), not to exceed +3.63V
Operating Temperature Range .....-40°C to +125°C

Storage Temperature Range ......See J-STD-020 Specification
Soldering Temperature Range ......See J-STD-020 Specification

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### RECOMMENDED OPERATING CONDITIONS

 $(TA = -40^{\circ}C \text{ to } +125^{\circ}C, \text{ unless otherwise noted.})$ 

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Supply Voltage	V <sub>CC</sub>	(Note 1)	3.0		3.6	V
Input Logic 1	VIH		0.8 x V <sub>CC</sub>		V <sub>CC</sub> + 0.3	V
Input Logic 0	VIL		-0.3		0.2 x V <sub>C</sub> C	V
Input Logic Float (SSEN, CRSEL)	VFLOAT	0V < V <sub>IN</sub> < V <sub>CC</sub>			±1	μΑ
SSO Load		SSO < 80MHz			15	55
SSO Load	CL	80MHz ≤ SSO < 134MHz			7	pF
CLKIN Frequency	fIN		20		134	MHz
CLKIN Duty Cycle	fINDC		40		60	%

#### DC ELECTRICAL CHARACTERISTICS

( $V_{CC}$  = +3.0V to +3.6V,  $T_A$  = -40°C to +125°C, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Supply Current	Icc	$C_L = 7pF$ $f_{IN} = 134MHz$			15	mA
SMSEL1/SMSEL2/CLKIN Input Leakage	I <sub>IL:1</sub>	0V < VIN < VCC	-1		+1	μΑ
CRSEL/SSEN Input Leakage	I <sub>IL:2</sub>	0V < VIN < VCC	-100		+100	μΑ
Output Leakage (SSO)	loz	SSEN = float	-1		+1	μΑ
Low-Level Output Voltage (SSO)	V <sub>OL</sub>	I <sub>OL</sub> = 4mA			0.4	V
High-Level Output Voltage (SSO)	VoH	I <sub>OH</sub> = -4mA	2.4	·		V

#### **AC ELECTRICAL CHARACTERISTICS**

( $V_{CC}$  = +3.0V to +3.6V,  $T_A$  = -40°C to +125°C, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
SSO Duty Cycle	fssodc	Measured at V <sub>CC</sub> /2	40		60	%
SSO Rise Time	t <sub>R</sub>	$C_L = 7pF$		1		ns
SSO Fall Time	tF	$C_L = 7pF$		1		ns
Peak Cycle-to-Cycle Jitter	tJ	$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}, 10,000 \text{ cycles}$		75		ps
Power-Up Time	tpor	(Note 2)			50	ms

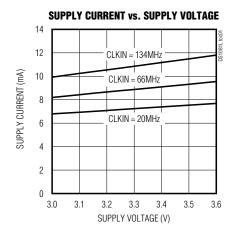
Note 1: All voltages referenced to ground. Currents into the IC are positive and out of the IC are negative.

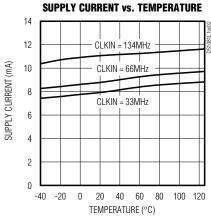
**Note 2:** Time between power applied to device and stable output.

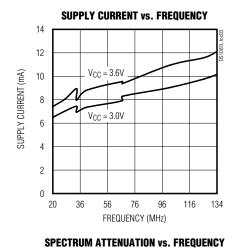


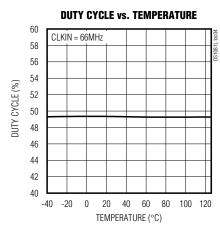
**Typical Operating Characteristics** 

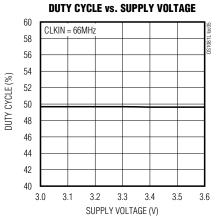
 $(T_A = +25^{\circ}C, \text{ unless otherwise noted.})$ 

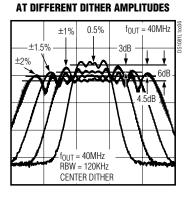












FREQUENCY (MHz)

ATTENUATION (dB)

## **Pin Description**

PIN	NAME	FUNCTION				
1	CLKIN	Clock Input. 20MHz to 134MHz clock input (fin).				
2	SMSEL2	Spread-Spectrum Magnitude Select Inputs. These digital inputs select the desired spread-spectrum magnitude as shown in the table below.				
_	00222	SMSEL2	SMSEL1	MAGNITUDE SELECTED		
		0	0	±2.0%		
		0	1	±1.5%		
3	SMSEL1	1	0	±1.0%		
		1	1	±0.5%		
4	GND	Ground				
5	SSEN	Spread-Spectrum Enable. Three-leve 0 = Power-up/spread-spectrum enal Float = SSO tri-stated.		pectrum and to tri-state the output.		
		1 = Power-up/spread-spectrum disa	bled (not a bypass mode).			
6	SSO	1 = Power-up/spread-spectrum disa Spread-Spectrum Clock Output. Out CLKIN.	· · · · · · · · · · · · · · · · · · ·	trum version of the clock input at		
6	SSO	Spread-Spectrum Clock Output. Out	puts a center-dithered spread-spec			
		Spread-Spectrum Clock Output. Out CLKIN.  Clock Range and Dither Rate Selection	puts a center-dithered spread-spec			
7	SSO	Spread-Spectrum Clock Output. Out CLKIN.  Clock Range and Dither Rate Select Description section for details.	puts a center-dithered spread-spec	the dither rate. See the Detailed		
		Spread-Spectrum Clock Output. Out CLKIN.  Clock Range and Dither Rate Select Description section for details.  CRSEL	puts a center-dithered spread-spect.  t. Three-level input that determines  CLKIN RANGE	the dither rate. See the <i>Detailed</i> DITHER RATE		
		Spread-Spectrum Clock Output. Out CLKIN.  Clock Range and Dither Rate Select Description section for details.  CRSEL  0	puts a center-dithered spread-spect. Three-level input that determines  CLKIN RANGE  66MHz to 134MHz	DITHER RATE  f <sub>IN</sub> /2048		

## **Detailed Description**

The DS1081L modulates an input clock to generate a center-dithered spread-spectrum output. A 20MHz to 134MHz clock is applied to the CLKIN pin. An internal PLL dithers the output clock about its center frequency at a user-selectable magnitude.

### **Spread-Spectrum Dither Magnitude**

The DS1081L can generate dither magnitudes up to ±2%. The desired magnitude is selected using input pins SMSEL1 and SMSEL2 as shown in Table 1.

Table 1.

SMSEL2	SMSEL1	MAGNITUDE
0	0	±2.0%
0	1	±1.5%
1	0	±1.0%
1	1	±0.5%

### **Spread-Spectrum Dither Rate**

The output spread-spectrum dither rate is determined by the input frequency to maximize EMI reduction and to ensure that the dither rate is always above the audio frequency range. The user must configure CRSEL, based on Table 2, depending on the input frequency (fIN) so that the appropriate dither rate is programmed.

Table 2.

CRSEL	CLKIN RANGE	DITHER RATE
0	66MHz to 134MHz	f <sub>IN</sub> /2048
Float	33MHz to 80MHz	f <sub>IN</sub> /1024
1	20MHz to 38MHz	f <sub>IN</sub> /512



### Spread-Spectrum Enable

On power-up, the output clock (SSO) remains tri-stated until the internal PLL reaches a stable frequency. The SSEN input can be used to disable the spread-spectrum modulation and to tri-state the SSO output. If the SSEN pin is pulled high, the spread-spectrum modulation is turned off, but the device still uses the internal PLL to generate the clock signal at SSO. If the SSEN pin is floated, the output will be tri-stated.

# **Application Information**

### **Power-Supply Decoupling**

To achieve best results, it is highly recommended that a decoupling capacitor is used on the IC power-supply pins. Typical values of decoupling capacitors are  $0.01\mu F$  and  $0.1\mu F$ . Use a high-quality, ceramic, surface-mount capacitor, and mount it as close as possible to the V<sub>CC</sub> and GND pins of the IC to minimize lead inductance.

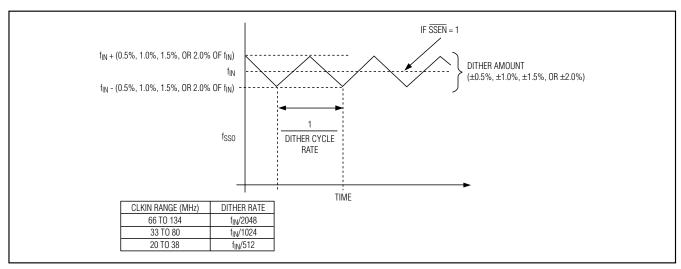
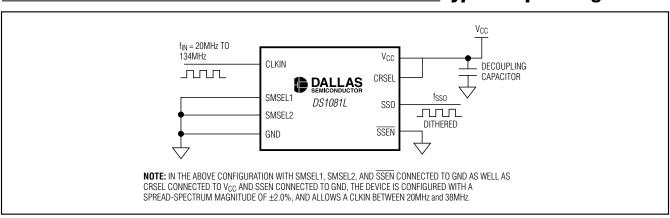


Figure 1. DS1081L Spread-Spectrum Frequency Modulation

# **Typical Operating Circuit**



# Package Information

For the latest package outline information, go to www.maxim-ic.com/DallasPackInfo

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